2SC3977, 2SC3977A

Silicon NPN triple diffusion planar type

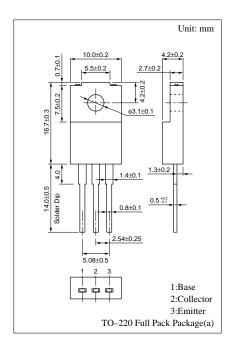
For high breakdown voltage high-speed switching

Features

- High-speed switching
- High collector to base voltage V_{CBO}
- Wide area of safe operation (ASO)
- Satisfactory linearity of foward current transfer ratio h_{FE}
- Full-pack package which can be installed to the heat sink with one screw

Absolute Maximum Ratings (T_C=25°C)

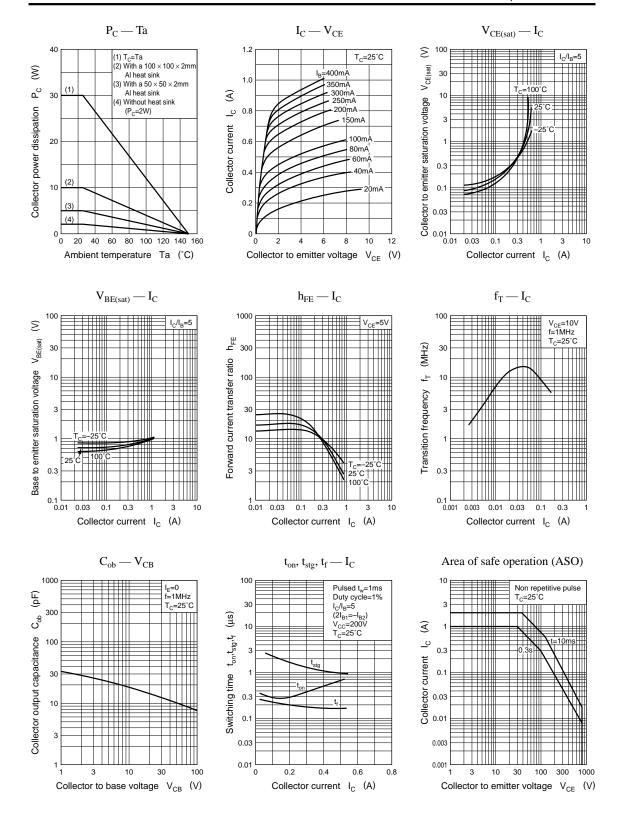
Parameter		Symbol	Ratings	Unit	
Collector to	2SC3977	V	900	V	
base voltage	2SC3977A	V_{CBO}	1000		
Collector to	2SC3977	37	900	V	
emitter voltage	2SC3977A	V_{CES}	1000		
Collector to emitter voltage		V_{CEO}	800	V	
Emitter to base voltage		V_{EBO}	7	V	
Peak collector current		I_{CP}	2	A	
Collector current		I_{C}	1	A	
Base current		I_B	0.3	A	
Collector power	T _C =25°C	D	30	X V	
dissipation	Ta=25°C	P_{C}	2	W	
Junction temperature		T _j	150	°C	
Storage temperature		$T_{\rm stg}$	-55 to +150	°C	



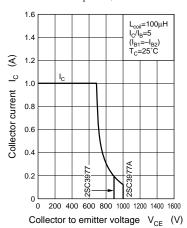
Electrical Characteristics (T_C=25°C)

Parameter		Symbol	Conditions	min	typ	max	Unit
Collector cutoff	2SC3977	т	$V_{CB} = 900V, I_E = 0$			50	μА
current	2SC3977A	I _{CBO}	$V_{CB} = 1000V, I_E = 0$			50	
Emitter cutoff current		I_{EBO}	$V_{EB} = 7V$, $I_C = 0$			50	μΑ
Collector to emitter voltage		V _{CEO}	$I_{\rm C} = 10 {\rm mA}, I_{\rm B} = 0$	800			V
Forward current transfer ratio		h _{FE1}	$V_{CE} = 5V, I_{C} = 0.1A$	8			
		h _{FE2}	$V_{CE} = 5V, I_{C} = 0.2A$	3			
Collector to emitter saturation voltage		V _{CE(sat)}	$I_C = 0.2A, I_B = 0.04A$			1.5	V
Base to emitter saturation voltage		V _{BE(sat)}	$I_C = 0.2A, I_B = 0.04A$			1.5	V
Transition frequency		f_T	$V_{CE} = 10V, I_{C} = 0.05A, f = 1MHz$		15		MHz
Turn-on time Storage time		t _{on}	$I_C = 0.2A, I_{B1} = 0.04A, I_{B2} = -0.08A,$			0.7	μs
		t _{stg}				2.5	μs
Fall time		$t_{\rm f}$	$V_{CC} = 250V$			0.3	μs

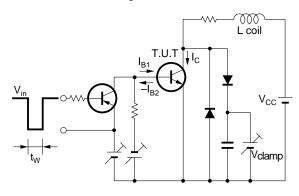
Panasonic 1



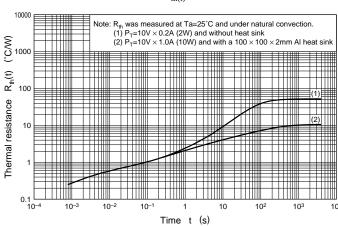
Area of safe operation, reverse bias ASO



Reverse bias ASO measuring circuit



 $R_{th(t)} -\!\!\!- t$



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